

C2824C223KDGACTU

Aliases (C2824C223KDGAC7800) SMD Comm COG HV, Ceramic, 0.022 uF, 10%, 1,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 2824, 4.2 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	540 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	2824
L	7.1mm +/-0.4mm
W	6.1mm +/-0.4mm
Т	2.5mm +/-0.20mm
S	4.2mm MIN
В	1.27mm +/-0.4mm

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S	4.2mm MIN
В	1.27mm +/-0.4mm
Packaging Specifications	

Specifications	
Capacitance	0.022 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	45.4545 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	300

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